HAM Project Meeting

Current Progress:

* COM Port (Colin)
* Code up to date for current microcontroller.
* Ready to Solder Today
* Casing

Moving Forward:

* Finish Soldering by end of the week.
	+ Tack the ICs that are big enough to get a solder iron to so that alignment doesn’t shift.
	+ Add the solder flux to all pads
* Finishing Code with new Microcontroller.
* Testing (Do board testing first, make sure nothing gets hot)
	+ Then put in code piece by piece. Not all at once. Possibly subsystem by subsystem.
* Milling Casing
	+ Talk to Natalie Gedde (Drill Press as well as sander)
* Demo with Schafer
	+ Print out a list of requirements
	+ Show that we met said requirements
	+ Sometime before Friday

Questions

* Solder Paste Screen
* Components on bottom of board
* How to get authorization for mill